

## Features

- **4 Input Clocks**
  - One crystal/CMOS input
  - Two differential/CMOS inputs
  - One single-ended/CMOS input
  - Any input frequency from 9.72MHz to 1250MHz (9.72MHz to 300MHz for CMOS)
  - Clock selection by pin or register control
- **Low-jitter Fractional-N APLL and 3 Outputs**
  - Any output frequency from <1Hz to 1035MHz
  - High-resolution fractional frequency conversion with 0ppm error
  - Easy-to-configure, encapsulated design requires no external VCXO or loop filter components
  - Each output has independent dividers
  - Output jitter is typically 0.16 to 0.28ps RMS (12kHz-20MHz integration band)
  - Outputs are CML or 2xCMOS, can interface to LVDS, LVPECL, HSTL, SSTL and HCSL
  - In 2xCMOS mode, the P and N pins can be different frequencies (e.g. 125MHz and 25MHz)
  - Per-output supply pin with CMOS output voltages from 1.5V to 3.3V

## Ordering Information

ZL30250LDG1	32 Pin QFN	Trays
ZL30250LDF1	32 Pin QFN	Tape and Reel
ZL30251LDG1	32 Pin QFN	Trays
ZL30251LDF1	32 Pin QFN	Tape and Reel

Matte Tin

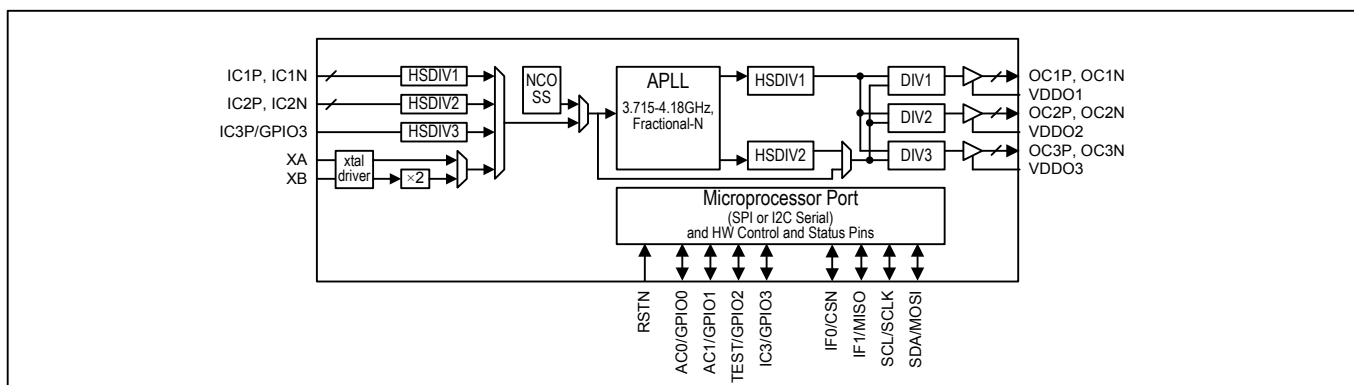
Package size: 5 x 5 mm

**-40°C to +85°C**

- Precise output alignment circuitry and per-output phase adjustment
- Per-output enable/disable and glitchless start/stop (stop high or low)
- **General Features**
  - Automatic self-configuration at power-up from external (ZL30250) or internal (ZL30251) EEPROM; up to four configs, pin-selectable
  - Numerically controlled oscillator mode
  - Spread-spectrum modulation mode
  - SPI or I<sup>2</sup>C processor Interface
  - Tiny 5x5mm QFN package
  - Easy-to-use evaluation software

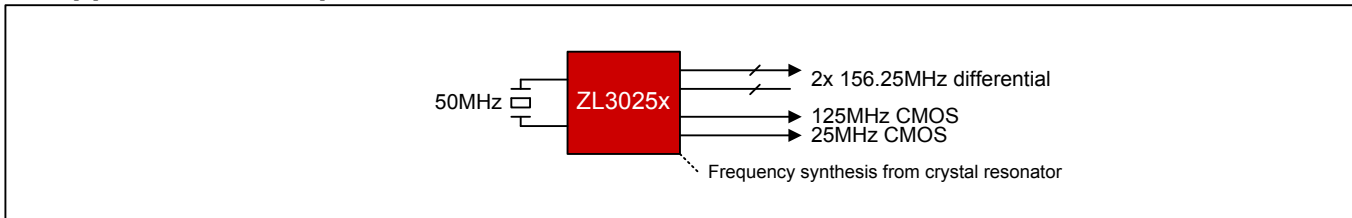
## Applications

- Frequency conversion and frequency synthesis in a wide variety of equipment types

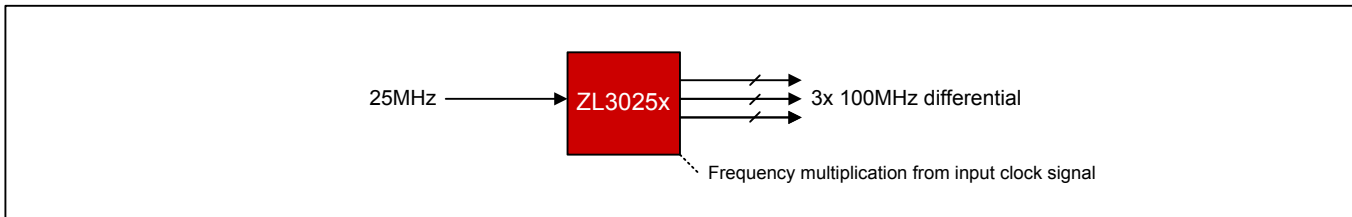


**Figure 1 - Functional Block Diagram**

## 1. Application Examples



**Figure 2 – Ethernet Frequency Synthesis Application**



**Figure 3 – PCI Express Frequency Multiplication Application**

## 2. Detailed Features

### 2.1 Input Clock Features

- Four input clocks: one crystal/CMOS, two differential/CMOS, one single-ended/CMOS
- Input clocks can be any frequency from 9.72MHz up to 1250MHz (differential) or 300MHz (CMOS)

### 2.2 APLL Features

- Very high-resolution fractional scaling (i.e. non-integer multiplication)
- Any-to-any frequency conversion with 0ppm error
- Two high-speed dividers (integers 4 to 15, half divides 4.5 to 7.5)
- Easy-to-configure, completely encapsulated design requires no external VCXO or loop filter components
- Bypass mode supports system testing

### 2.3 Output Clock Features

- Three low-jitter output clocks
- Each output can be one differential output or two CMOS outputs
- Output clocks can be any frequency from 1Hz to 1035MHz (250MHz max for CMOS and HSTL outputs)
- Output jitter is typically 0.16 to 0.28ps RMS (12kHz to 20MHz integration band)
- In CMOS mode, an additional divider allows the OCxN pin to be an integer divisor of the OCxP pin (Example: OC3P 125MHz, OC3N 25MHz)
- Outputs easily interface with CML, LVDS, LVPECL, HSTL, SSTL, HCSL and CMOS components
- Supported telecom frequencies include PDH, SDH, Synchronous Ethernet, OTN
- Can produce clock frequencies for microprocessors, ASICs, FPGAs and other components
- Can produce PCIe clocks (PCIe gen. 1, 2 and 3)
- Sophisticated output-to-output phase alignment
- Per-output phase adjustment with high resolution and unlimited range
- Per-output enable/disable
- Per-output glitchless start/stop (stop high or low)

## 2.4 General Features

- SPI or I<sup>2</sup>C serial microprocessor interface
- Automatic self-configuration at power-up from external (ZL30250) or internal (ZL30251) EEPROM memory; pin control to specify one of four stored configurations
- Numerically controlled oscillator (NCO) mode allows system software to steer frequency with resolution better than 0.01ppb
- Spread-spectrum modulation mode (meets PCI Express requirements)
- Four general-purpose I/O pins each with many possible status and control options
- Reference can be fundamental-mode crystal, low-cost XO or clock signal from elsewhere in the system

## 2.5 Evaluation Software

- Simple, intuitive Windows-based graphical user interface
- Supports all device features and register fields
- Makes lab evaluation of the ZL30250 or ZL30251 quick and easy
- Generates configuration scripts to be stored in external (ZL30250) or internal (ZL30251) EEPROM
- Generates full or partial configuration scripts to be run on a system processor
- Works with or without a ZL30250 or ZL30251 evaluation board



**Microsemi Corporate Headquarters**  
One Enterprise, Aliso Viejo CA 92656 USA  
Within the USA: +1 (949) 380-6100  
Sales: +1 (949) 380-6136  
Fax: +1 (949) 215-4996  
Email: [sales.support@microsemi.com](mailto:sales.support@microsemi.com)

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